

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	99612	DRAM	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/10 14:04
S2	2	"20020100957"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/10 14:45
S3	2	"20010019167"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/10 14:58
S4	0	10/616234	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/10 14:44
S5	3	("6407586").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/10 14:44
S6	4034	(257/209,529,758).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/10 14:59
S7	5091	(438/118,623,128,129,132,215, 281,333,601).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/10 15:00
S8	0	(interconnect near3 plane) near5 (passiv\$4 near substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/10 15:02
S9	0	(interconnect near3 plane) with (passiv\$4 near substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/10 15:16

S10	0	(interconnect near3 plane) with (passiv\$5 near substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/10 15:03
S11	3	(interconnect near3 plane) with (passiv\$5 near layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/10 15:04
S12	545	(interconnect near3 (plane layer)) with (passiv\$5 near layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/10 15:05
S13	442	(interconnect near3 (plane layer)) near5(passiv\$5 near layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/10 15:05
S14	442	(interconnect near3 (plane layer)) near5 (passiv\$5 near layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/10 17:08
S15	1	fuse adj device near5 fuse near module	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/10 15:10
S16	1	fuse adj device with fuse near module	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/10 17:29
S17	852	S14 fuse near module	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/10 17:09
S18	0	S14 and fuse near module	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/10 15:20
S19	3	S14 and fuse near device	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/10 15:12

S20	28	S14 and fuse	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/10 15:12
S21	3	(interconnect near3 plane) and (passiv\$4 near substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/10 15:17
S22	3	(interconnect near3 plane) and (passiv\$4 near (substrate layer))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/10 15:19
S23	164	(interconnect near3 (plane layer)) and (passiv\$4 near (substrate layer))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/10 15:19
S24	0	S23 and fuse near module	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/10 15:20
S25	1	S23 and fuse near device	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/10 15:21
S26	13	S23 and fuse	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/10 16:56
S28	296	(interconnect near3 (plane layer)) near5 (passiv\$5 near layer) and "257"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/10 17:10
S29	270707	"129" fuse near module	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/10 17:09
S30	0	S28 and fuse near module	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/10 17:25

S31	22	S28 and fuse	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/11 11:20
S32	10	fuse adj device and fuse near module	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/11 08:50
S33	0	S32 and predetermin\$4 near potential	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/10 17:31
S34	0	S32 and (predetermin\$4 preset\$3 select\$3) near potential	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/10 17:31
S35	6	S17 and (predetermin\$4 preset\$3 select\$3) near potential	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/10 17:32
S36	30	fuse adj device and fuse near3 module	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/11 08:50
S37	0	S36 and central near interconnect\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/11 08:59
S38	2	S36 and fuse near pairs	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/11 09:00
S39	99612	DRAM	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/11 08:55
S40	4	S36 and S39	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/11 08:57

S41	454	(327/525).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/11 08:57
S42	0	S41 and central near interconnect\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/11 08:59
S43	0	S41 and ((central main) near interconnect\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/11 09:00
S44	16	S41 and fuse near pairs	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/11 09:01
S45	111	S39 and S41	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/11 09:02
S46	99612	DRAM	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/11 11:20
S47	296	(interconnect near3 (plane layer)) near5 (passiv\$5 near layer) and "257"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/11 11:20
S48	22	S47 and fuse	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/11 11:20
S49	6	S48 and S46	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/11 11:21